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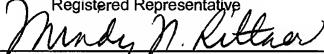
December 5, 2007

Date of Deposit

Mindy N. Rittner, Ph.D. – Reg. No. 57,803

Name of applicant, assignee or

Registered Representative



Signature

Dec. 5, 2007

Date of Signature

Our Case No. 10322/57
Client Ref. No. TF03009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kuang Chien Hsieh et al.

Serial No. 10/680,509

Filing Date: October 7, 2003

For ADHESIVE BONDING WITH LOW
TEMPERATURE GROWN AMORPHOUS
OR POLYCRYSTALLINE COMPOUND
SEMICONDUCTORS

Examiner: Hoa B. Trinh

Group Art Unit No. 2814

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This communication is in response to the Office Action dated October 12, 2007. Applicants respectfully request that the Examiner reconsider the rejections of the claims in view of the following remarks and amendments.

Amendments to the Claims begin on page 2.

Remarks begin on page 14.